L Number	Hits	Search Text	DB	Time stamp
1	4418	(bonding or wirebonding) near3 (pad or	USPAT;	2004/09/28 12:00
		electrode) near15 (non-oxidizing or	US-PGPUB;	2001,03,20 12:00
		nonoxidizing or gold or Au or platinum or Pt	EPO; JPO;	
		or palladium or pd)	DERWENT;	
			IBM_TDB	
2	4419	(bonding or wirebonding) near3 (pad or	USPAT;	2004/09/28 12:00
		electrode) near15 (non-oxidiz\$5 or	US-PGPUB;	
		nonoxidiz\$5 or non adj oxidiz\$5 or gold or	EPO; JPO;	
		Au or platinum or Pt or palladium or pd)	DERWENT;	
3	817	   (bonding or wirebonding) near2 (pad or	IBM_TDB USPAT;	2004/09/28 12:12
	]	electrode) near10 (barrier or adhesion or Cr	US-PGPUB;	2004/03/28 12:12
		or chromium or copper or cu or vanadium or v	EPO; JPO;	
		or crcu or nickel or ni) near10	DERWENT;	
		(non-oxidizing or nonoxidizing or gold or Au	IBM_TDB	
		or platinum or Pt or palladium or pd)	_	
4	294	, , , , , , , , , , , , , , , , , , , ,	USPAT;	2004/09/28 13:10
		(pad or electrode) near10 (barrier or	US-PGPUB;	
		adhesion or Cr or chromium or copper or cu	EPO; JPO;	
		or vanadium or v or crcu or nickel or ni)	DERWENT;	
		near10 (non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or	IBM_TDB	
		pd)		
5	20	("5445311"   "5567981"   "5792594"	USPAT	2004/09/28 12:48
		"5910644"   "6064112"   "6127736"		
		"6218281"   "6232147"   "6303524"		
		"6335104"   "6372624"   "6380555"		
		"6388333"   "6396148"   "6403457"		
		"6451624"   "6455408"   "6501165"		
6	89	"6620633"   "6620731").PN.	HODAM	2004/00/20 12 21
0	69	(bonding or wirebonding) near5 (pad or electrode) near10 (barrier or adhesion or Cr	USPAT; US-PGPUB;	2004/09/28 13:31
		or chromium or copper or cu or vanadium or v	EPO; JPO;	
		or crcu or nickel or ni) near10	DERWENT;	
		(non-oxidizing or nonoxidizing or gold or Au	IBM TDB	
		or platinum or Pt or palladium or pd) same	_	
		(redistribution or redistributing or		
		redistribute or redistributed or trace or		
-	3.5	finger or interconnect)	*****	0004/00/00 10 15
7	35	(non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) near8	USPAT; US-PGPUB;	2004/09/28 13:45
		(seal or sealing or enveloping or sealed or	EPO; JPO;	
		enveloped or surrounding or surrounded or	DERWENT;	
		surround) near10 (redistribution or	IBM TDB	
		redistributing or redistribute or	_	
		redistributed or trace or finger or		
	_	interconnect)		0004/05/55
8	5	(non-oxidizing or nonoxidizing or gold or Au	USPAT;	2004/09/28 13:42
		or platinum or Pt or palladium or pd) near8 (covering or cover or covered) near2	US-PGPUB; EPO; JPO;	
		(completely or wholly or edges or entirely	DERWENT;	
		or complete or entire) near10	IBM TDB	
		(redistribution or redistributing or		
		redistribute or redistributed or trace or		
		finger or interconnect)		
9	5	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au	USPAT;	2004/09/28 13:42
		or platinum or Pt or palladium or pd) near8	US-PGPUB;	
		(covering or cover or covered) near2	EPO; JPO;	
	1	(completely or wholly or edges or entirely or complete or entire) near10	DERWENT; IBM TDB	
		(redistribution or redistributing or	15.5_156	
		redistribute or redistributed or trace or		
		finger or interconnect)		
10	14	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au	USPAT;	2004/09/28 13:42
		or platinum or Pt or palladium or pd) near8	US-PGPUB;	
		(covering or cover or covered) near2	EPO; JPO;	
		(completely or wholly or edges or entirely	DERWENT;	
		or complete or entire) near10	IBM_TDB	
		(redistribution or redistributing or redistribute or redistributed or trace or		
		finger or interconnect or wiring)		
			I	L

	36	(non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) near8 (seal or sealing or enveloping or sealed or enveloped or surrounding or surrounded or surround) near10 (wirebonding or wirebond or wirebonded or wire near bonding or wire near bonding or wire near bonded) near3 (pad or electrode or surface or area or region)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:46
12	36	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au or platinum or Pt or palladium or pd) near8 (seal or sealing or enveloping or sealed or enveloped or surrounding or surrounded or surround) near10 (wirebonding or wirebond or wirebonded or wire near bonding or wire near bonding or wire near bonded) near3 (pad or electrode or surface or area or region)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:46